onsemi

Silicon Carbide (SiC) MOSFET - EliteSiC, 23 mohm, 650 V, M3S, TO-247-4L

NVH4L023N065M3S

Features

- Typical $R_{DS(on)} = 23 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge ($Q_{G(tot)} = 69 \text{ nC}$)
- High Speed Switching with Low Capacitance (Coss = 153 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with Exemption 7a, Pb–Free 2LI (on second level interconnection)

Applications

- Automotive On Board Charger
- Automotive DC-DC Converter for EV/HEV

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

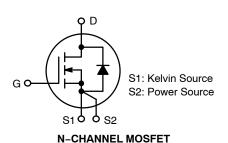
Parameter		Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	650	V	
Gate-to-Source Voltage		V _{GS}	-8/+22	V
Continuous Drain Current	Continuous Drain Current $T_{\rm C} = 25^{\circ}{\rm C}$		67	А
Power Dissipation		PD	245	W
Continuous Drain Current	T _C = 100°C	I _D	47	А
Power Dissipation		PD	122	W
Pulsed Drain Current (Note 1)	T _C = 25°C t _p = 100 μs	I _{DM}	225	A
Continuous Source-Drain Current (Body Diode)	$T_{C} = 25^{\circ}C$ $V_{GS} = -3 V$	I _S	37	A
	$\begin{array}{l} T_{C} = 100^{\circ}C \\ V_{GS} = -3 \ V \end{array}$		23	
Pulsed Source-Drain Current (Body Diode) (Note 1)	$\begin{array}{l} T_C = 25^\circ C \\ V_{GS} = -3 \ V \\ t_p = 100 \ \mu s \end{array}$	I _{SM}	188	A
Single Pulse Avalanche Energy (Note 2)	I _{LPK} = 19.6 A, L = 1 mH	E _{AS}	192	mJ
Operating Junction and Storage T Range	T _J , T _{stg}	–55 to +175	°C	
Lead Temperature for Soldering P (1/8" from case for 10 seconds)	ΤL	270	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Single pulse, limited by max junction temperature.

2. E_{AS} of 192 mJ is based on starting T_J = 25°C, L = 1 mH, I_{AS} = 19.6 A, V_{DD} = 100 V, V_{GS} = 18 V

V _{(BR)DSS}	R _{DS(ON)} TYP	I _D MAX
650 V	23 mΩ @ 18 V	67 A





MARKING DIAGRAM



H4L023065M3S = Specific Device Code

A = Assembly Location

Y = Year

- WW = Work Week
- ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping
NVH4L023N065M3S	TO-247-4L	30 Units / Tube

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 3)		0.61	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	R_{\thetaJA}	40	

3. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value	Unit
Operation Values of Gate-to-Source Voltage	V _{GSop}	-53 +18	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 1 mA, T_J = 25°C	650	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	$\Delta V_{(BR)DSS}/ \Delta T_J$	$I_D = 1$ mA, Referenced to 25°C	-	89	-	mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 650 V, T_J = 25°C	-	-	10	μA
		V_{DS} = 650 V, T_J = 175°C (Note 5)	-	-	500	μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = -8/+22$ V, $V_{DS} = 0$ V	-	-	±1.0	μA
ON CHARACTERISTICS						
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 18 V, I_D = 20 A, T_J = 25°C	-	23	33	mΩ
		V _{GS} = 18 V, I _D = 20 A, T _J = 175°C (Note 5)	-	34	-	
		V_{GS} = 15 V, I_D = 20 A, T_J = 25°C	-	29	-	
		V_{GS} = 15 V, I _D = 20 A, T _J = 175°C (Note 5)	-	37	-	
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 10 mA, T_J = 25°C	2	2.8	4	V
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 20 A (Note 5)	-	14	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C _{ISS}	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	-	1952	-	pF
Output Capacitance	C _{OSS}	(Note 5)	-	153	-	1
Reverse Transfer Capacitance	C _{RSS}		_	13	-	1
Total Gate Charge	Q _{G(TOT)}	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 20 \text{ A},$	-	69	-	nC
Gate-to-Source Charge	Q _{GS}	V _{GS} = -3/18 V (Note 5)	-	19	-	
Gate-to-Drain Charge	Q _{GD}		-	18	-	
Gate Resistance	R _G	f = 1 MHz	-	4.0	-	Ω
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DD} = 400 \text{ V},$	-	11	-	ns
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 20 \text{ A}, \text{ R}_G = 4.7 \Omega, \text{ T}_J = 25^{\circ}\text{C}$ (Notes 4 and 5)	-	35	-	
Rise Time	t _r		-	15	-]
Fall Time	t _f		_	9.6	-	
Turn-On Switching Loss	E _{ON}		-	51	-	μJ
Turn-Off Switching Loss	E _{OFF}		_	29	-]
Total Switching Loss	E _{TOT}		-	80	-]



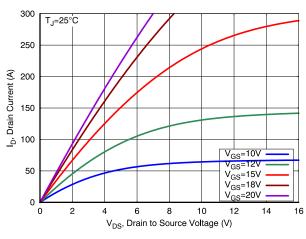
ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS	•	-	•			
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DD} = 400 \text{ V},$	-	9.6	_	ns
Turn-Off Delay Time	t _{d(OFF)}	I _D = 20 A, R _G = 4.7 Ω, T _J = 175°C (Notes 4 and 5)	-	41	_	
Rise Time	t _r		-	14	-	
Fall Time	t _f		-	12	_	
Turn-On Switching Loss	E _{ON}		-	51	-	μJ
Turn–Off Switching Loss	E _{OFF}		-	45	_	
Total Switching Loss	E _{TOT}		-	96	_	
SOURCE-TO-DRAIN DIODE CHARAG	TERISTICS					
Forward Diode Voltage	V _{SD}	I_{SD} = 20 A, V_{GS} = –3 V, T_J = 25°C	-	4.5	6.0	V
		I_{SD} = 20 A, V_{GS} = -3 V, T_{J} = 175°C (Note 5)	_	4.2	-	
Reverse Recovery Time	t _{RR}	$V_{GS} = -3 V$, $I_{S} = 20 A$,	-	19	_	ns
Charge Time	t _a	dl/dt = 1000 A/μs, V _{DS} = 400 V, T _{.I} = 25°C (Note 5)	-	11	_	
Discharge Time	t _b		-	8	_	
Reverse Recovery Charge	Q _{RR}	1	-	97	-	nC
Reverse Recovery Energy	E _{REC}]	-	8.7	-	Lμ
Peak Reverse Recovery Current	I _{RRM}	1	-	11	_	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. EON/EOFF result is with body diode. 5. Defined by design, not subject to production test.



TYPICAL CHARACTERISTICS





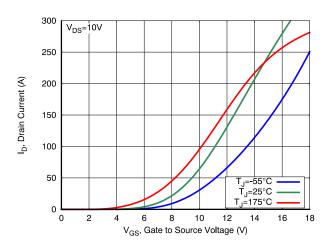


Figure 3. Transfer Characteristics

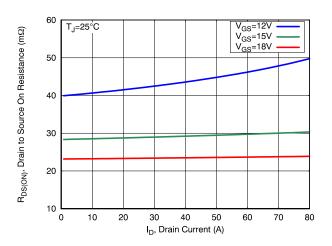
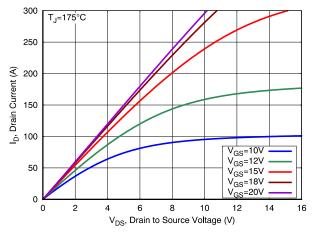


Figure 5. On-Resistance vs Drain Current





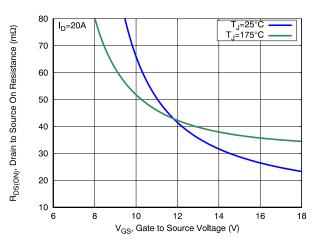
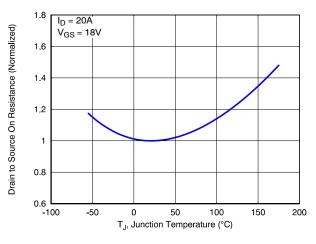
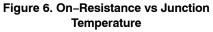


Figure 4. On-Resistance vs Gate Voltage







TYPICAL CHARACTERISTICS

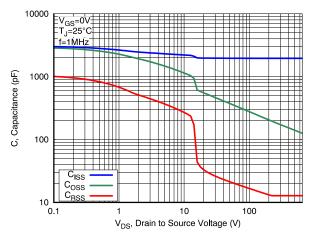


Figure 7. Capacitance Characteristics

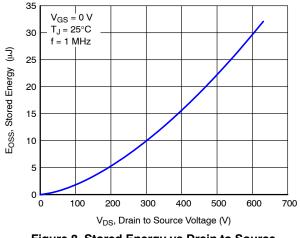


Figure 8. Stored Energy vs Drain to Source Voltage

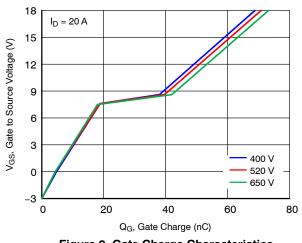


Figure 9. Gate Charge Characteristics

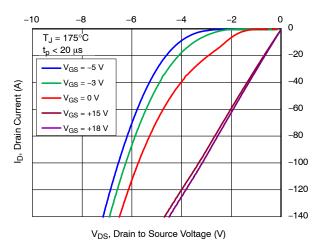
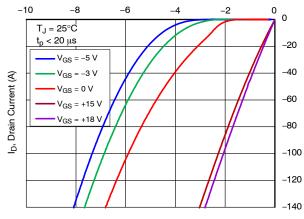
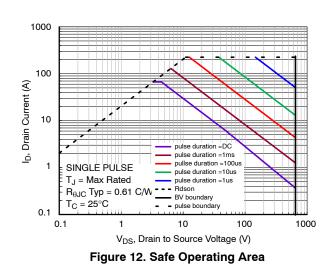


Figure 11. Reverse Conduction Characteristics

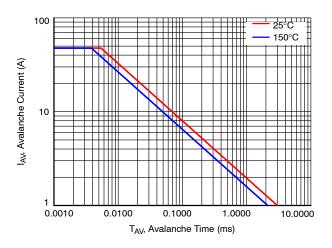


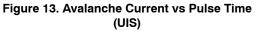
V_{DS}, Drain to Source Voltage (V)

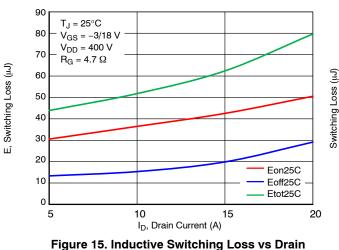




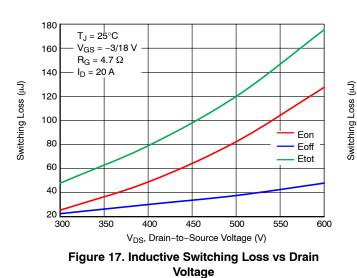
TYPICAL CHARACTERISTICS







Current



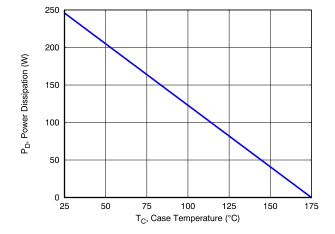


Figure 14. Maximum Power Dissipation vs Case Temperature

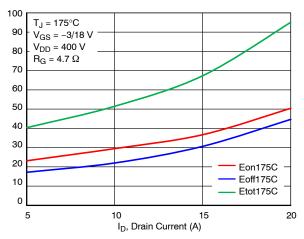
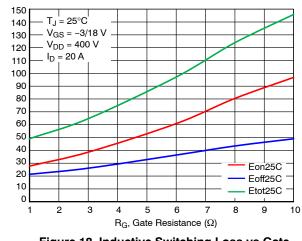


Figure 16. Inductive Switching Loss vs Drain Current

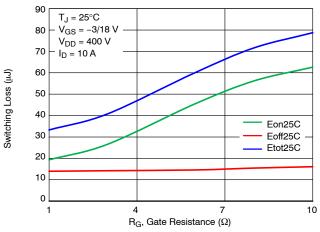




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TYPICAL CHARACTERISTICS





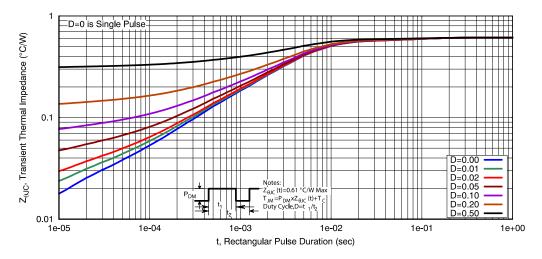


Figure 20. Thermal Response Characteristics





TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

NOM

5.00

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2.00

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1.40

2.22

0.60

22.54

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2.54 BSC

5.08 BSC

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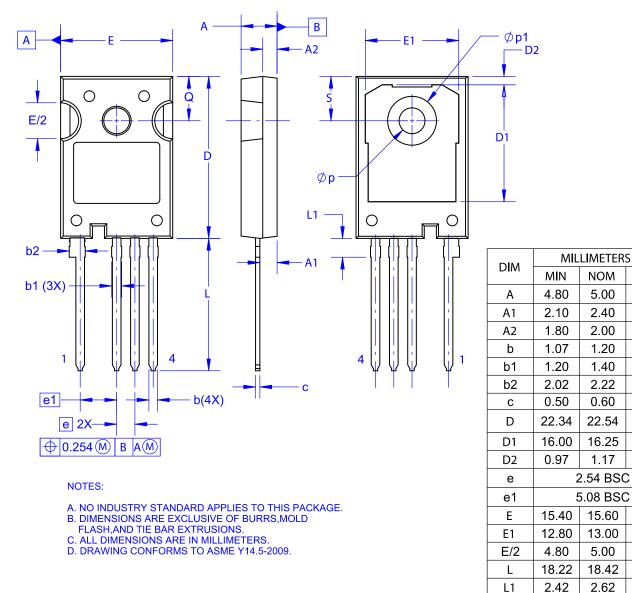
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TO-247-4LD CASE 340CJ **ISSUE A**

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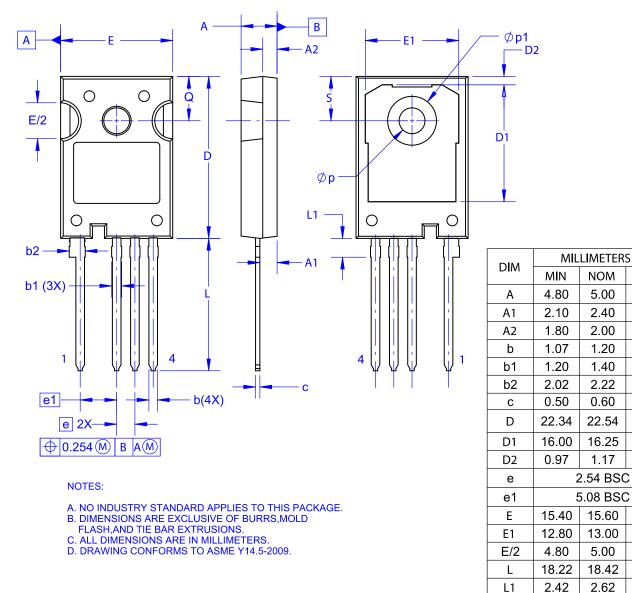
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